

650V XPT[™] Trench IGBTs

Highly Efficient Low On-State Voltage IGBTs

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Product Line Introduction (650V XPT™ Trench IGBTs)







- Broadest discrete IGBTs portfolio at 650V (19 parts so far)
- From 30A to 200A current ratings at high temperature $T_c = 110^{\circ}C$
- Developed using IXYS' eXtreme-light Punch-Through (XPT[™]) thin-wafer technology and state-of-the-art Trench IGBT process
- Designed for high-efficiency power conversion applications
- Low on-state voltages
- Short circuit capability (10µs)
- Low gate drive requirements
- Available in international standard packages (TO-247, TO-264, SOT-227B, PLUS247, ISOPLUS247™)
- Also available (upon request) in surface-mountable ultra-low profile SMPD and Mini-SMPD packages



Technology Advantages

XPT™ Design Platform and GenX4™ Trench IGBT Process

- Thin wafer technology
- Reduced thermal resistance (R_{thJC})
- Low energy losses
- Fast switching
- Low tail current
- Higher current densities
- Positive temperature coefficient of V_{CE(sat)}

Exceptional Ruggedness

- Reverse Bias Safe Operating Area (RBSOA)
 - "Square" up to the breakdown voltage of 650V
 - Able to operate without snubbers in hard-switching applications

Short Circuit Safe Operating Area (SCSOA)

- 10µs at a high temperature of 150°C
- Ideal for motor drive applications

Ultra-Fast Anti-Parallel Sonic-FRD™ Diode

- Temperature stability of diode forward voltage V_F
- Optimized to reduce turn-off losses and suppress ringing oscillations
- Low electromagnetic interference (EMI)
- Short reverse recovery times (t_{rr})





650V XPT[™] Trench IGBTs Summary Table

The largest selection of 650V IGBTs available in the industry!

Part Number	V _{GS} (V)	I _{c25} T _c =25°C (A)	l _{c110} T _c =110°C (A)	V _{cE(sat)} max T _j =25°C (V)	t _n typ Tj=150°C (ns)	E _{off} typ T _j =150°C (mJ)	R _{thic} max IGBT (°C/W)	Configuration	Package Style
IXXH30N65B4	650	65	30	2	100	0.6	0.65	Single	TO-247
IXXH60N65B4H1	650	116	60	2	94	1.34	0.33	Copacked (Sonic-FRD™)	TO-247
IXXH60N65B4	650	116	60	2	94	1.34	0.33	Single	TO-247
IXXH60N65C4	650	118	60	2.2	47	0.93	0.33	Single	TO-247
IXXH40N65B4	650	120	40	1.8	73	0.78	0.33	Single	TO-247
IXXR110N65B4H1	650	150	70	2.15	105	1.4	0.33	Copacked (Sonic-FRD™)	ISOPLUS247™
IXXH80N65B4	650	160	80	2	65	1.65	0.24	Single	TO-247
IXXH80N65B4H1	650	160	80	2	65	1.65	0.24	Copacked (Sonic-FRD [™])	TO-247
IXXN110N65C4H1	650	210	110	2.35	43	0.77	0.2	Copacked (Sonic-FRD™)	SOT-227B
IXXN110N65B4H1	650	215	110	2.1	105	1.4	0.2	Copacked (Sonic-FRD [™])	SOT-227B
IXXH110N65C4	650	234	110	2.35	43	0.77	0.17	Single	TO-247
IXXK110N65B4H1	650	240	110	2.1	105	1.4	0.17	Copacked (Sonic-FRD™)	TO-264
IXXX110N65B4H1	650	240	110	2.1	105	1.4	0.17	Copacked (Sonic-FRD™)	PLUS247
IXXK160N65C4	650	290	160	2.1	57	1.3	0.16	Single	TO-264
IXXX160N65C4	650	290	160	2.1	57	1.3	0.16	Single	PLUS247
IXXK160N65B4	650	310	160	1.8	160	2.36	0.16	Single	TO-264
IXXX160N65B4	650	310	160	1.8	160	2.36	0.16	Single	PLUS247
IXXK200N65B4	650	370	200	1.7	110	2.54	0.13	Single	TO-264
IXXX200N65B4	650	370	200	1.7	110	2.54	0.13	Single	PLUS247



Applications

Targeted for high-efficiency power conversion applications (hard or soft switching – up to 60kHz)





- battery chargers
- e-bikes
- Iamp ballasts
- motor drives
- power inverters
- power factor correction (PFC) circuits
- switch-mode power supplies
- uninterruptible power supplies (UPS)
- welding machines



Trade-Off Curve

Superior trade-off (turn-off energy loss vs. on-state voltage)







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